■ MN101C66D

Туре	MN101C66D (under development) 64 K			
ROM (×8-bit)				
RAM (×8-bit)	2 K			
Package	QFP084-P-1818E *Lead-free, LQFP080-P-1414A *Lead-free, TQFP080-P-1212D *Lead-free (under plannning)			
Minimum Instruction Execution Time	0.1 μs (at 4.5 V to 5.5 V, 20 MHz) 0.25 μs (at 2.7 V to 5.5 V, 8 MHz)*1 62.5 μs (at 2.0 V to 5.5 V, 32 kHz)*1.2 *1 The lower limit for operation guarantee for flash memory built-in type is 4.5 V. *2 The lower limit for operation guarantee for EPROM built-in type is 2.3 V.			
Interrupts	• RESET • Watchdog • External 0 • External 1 • External 2 • External 3*1 • External 4 (key interrupt dedicated) • Timer 0 • Timer 1 • Timer 2 • Timer 3 • Timer 6 • Time base • Timer 7 (2 systems) • Timer 8 (2 systems) • Serial 0 (2 systems) • Serial 2 • A/D conversion finish * LQFP080-P-1414A,TQFP080-P-1212D: Not mounted			
Timer Counter	Timer counter 0: 8-bit × 1 (square-wave/8-bit PWM output, event count, generation of remote control carrier, simple pulse width measurement) (square-wave/PWM output to large current terminal P50 possible) Clock source			
	Timer counter 1: 8-bit × 1 (square-wave output, event count, synchronous output event) Clock source			
	Timer counter 0, 1 can be cascade-connected.			
	Timer counter 2: 8-bit × 1 (square-wave output, additional pulse type 10-bit PWM output, event count, synchronous output event, simple pulse width measurement) (square-wave/PWM output to large current terminal P52 possible) Clock source			
	Timer counter 3: 8-bit × 1 (square-wave output, event count, generation of remote control carrier, serial 0 baud rate timer) Clock source			
	Timer counter 2, 3 can be cascade-connected.			
	Timer counter 6: 8-bit freerun timer Clock source			
	Timer counter 7: 16-bit × 1 (square-wave output, IGBT/16-bit PWM output (cycle / duty continuous variable), event count, synchronous output evevt, pulse width measurement, input capture) (square-wave/PWM output to large current terminal P51 possible) Clock source			

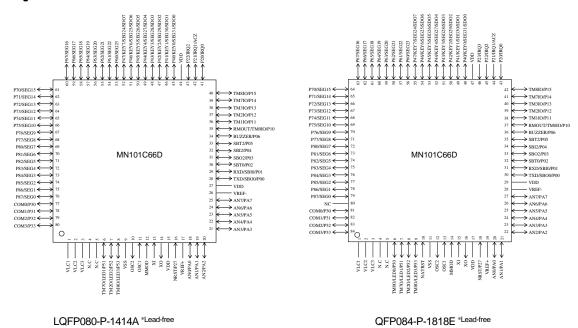
Timer Counter (Continue) Timer counter 8: 16 bit \times 1 (square-wave/16-bit PWM output [duty continuous variable], event count, pulse width measurement, inputcapture) (square-wave/PWM output to large current terminal P53 possible) Clock source ----- 1/1, 1/2, 1/4, 1/16, 1/128 of system clock frequency; 1/1, 1/2, 1/4, 1/16, 1/128 of OSC oscillation clock frequency; 1/1, 1/2, 1/4, 1/16 of external clock input frequency Interrupt source coincidence with compare register 8 (2 lines) Timer counters 7, 8 can be cascade-connected. (square-wave output, PWM, input capture, pulse width measurement is possible as a 32-bit timer.) Time base timer (one-minute count setting) Clock source 1/1 of OSC oscillation clock frequency; 1/1 of XI oscillation clock frequency Interrupt source ------ 1/128, 1/256, 1/512, 1/1024, 1/8192, 1/32768 of clock source frequency Watchdog timer Interrupt source ----- 1/65536, 1/262144, 1/1048576 of system clock frequency **Serial Interface** Serial 0: synchronous type/UART (full-duplex) × 1 1/2, 1/4, 1/16, 1/64 of OSC oscillation clock frequency Serial 2: synchronous type \times 1 Clock source ------ 1/2, 1/4 of system clock frequency; pulse output of timer counter 3; 1/2, 1/4, 1/16, 1/32 of OSC oscillation clock frequency I/O Pins 1/0 61 • Common use • Specified pull-up resistor available • Input/output selectable (bit unit) (60)(): LQFP080-P-1414A,TQFP080-P-1212D Input 4 • Common use • Specified pull-up resistor available (3) (): LQFP080-P-1414A,TQFP080-P-1212D A/D Inputs 10-bit \times 8-ch. (with S/H) LCD 32 segments \times 4 commons (static, 1/2, 1/3, or 1/4 duty) LCD power supply separated from VDD (usable if VLCD ≤VDD) LCD power shunt resistance contained **Special Ports** Buzzer output, remote control carrier signal output, high-current drive port

Electrical Characteristics

Supply current

Parameter	Symbol	Condition	Limit			Unit
			min	typ	max	Oill
	IDD1	fosc = 20 MHz, VDD = 5 V		25	60	mA
Operatingsupplycurrent	IDD2	2 fosc = 8 MHz, VDD = 5 V		10	25	mA
	IDD3	fx = 32 kHz, VDD = 3 V		30	100	μА
• • • • • • • • • • • • • • • • • • • •	IDD4	fx = 32 kHz, VDD = 3 V, Ta = 25°C		4	8	μА
Supply current at HALT	IDD5	$fx = 32 \text{ kHz}, VDD = 3 \text{ V}, Ta = -40^{\circ}\text{C to } +85^{\circ}\text{C}$			30	μА
0 - 1	IDD6	VDD = 5 V, Ta = 25°C			2	μА
Supply current at STOP	IDD7	$VDD = 5 \text{ V}, \text{ Ta} = -40^{\circ}\text{C to } +85^{\circ}\text{C}$			50	μА

Pin Assignment



Support Tool

TQFP080-P-1212D *Lead-free (under plannnig)

In-circuit Emulator	PX-ICE101C / D + PX-PRB101C66-QFP084-P-1818E-M PX-ICE101C / D + PX-PRB101C66-LQFP080-P-1414A-M		
EPROM Built-in Type	Туре	MN101CP66D [ES (Engineering Sample) available]	
	ROM (× 8-bit)	64 K	
	RAM (× 8-bit)	2 K	
	Minimum instruction execution time	0.1 μs (at 4.5 V to 5.5 V, 20 MHz)	
		$0.25~\mu s$ (at $2.7~V$ to $5.5~V, 8~MHz)$	
		$62.5~\mu s$ (at $2.3~V$ to $5.5~V,32~kHz)$	
	Package	LQFP080-P-1414A *Lead-free, QFP084-P-1818E *Lead-free,	
		TQFP080-P-1212D *Lead-free (under planning)	
Flash Memory Built-in Type	Туре	MN101CF66D [ES (Engineering Sample) available]	
	ROM (× 8-bit)	64 K	
	RAM (× 8-bit)	2 K	
	Minimum instruction execution time	0.1 μs (at 4.5 V to 5.5 V, 20 MHz)	
		$0.25~\mu s$ (at 4.5 V to 5.5 V, 8 MHz)	
		62.5 µs (at 4.5 V to 5.5 V, 32 kHz)	
	Package	LQFP080-P-1414A *Lead-free, QFP084-P-1818E *Lead-free,	
		TQFP080-P-1212D *Lead-free (under planning)	

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